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AMENDMENT TRANSMITTAL LETTER (Small Entity)

Applicant(s): Moon-Hee Hong, et al.

Docket No.

17289

Application No. 10/724,381	Filing Date November 28, 2003	Examiner Daniel J. Jenkins	Customer No. 23389	Group Art Unit 1742	Confirmation No. 9654
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Invention: W-CU ALLOY WITH HOMOGENOUS MICRO-STRUCTURE
AND THE MANUFACTURING METHOD THEREOF

JUL 08 2005

COMMISSIONER FOR PATENTS:

Transmitted herewith is an amendment in the above-identified application.

Applicant claims small entity status. See 37 CFR 1.27

The fee has been calculated and is transmitted as shown below.

CLAIMS AS AMENDED

	CLAIMS REMAINING AFTER AMENDMENT	HIGHEST # PREV. PAID FOR	NUMBER EXTRA CLAIMS PRESENT	RATE	ADDITIONAL FEE
TOTAL CLAIMS	6 -	20 =	0	x \$25.00	\$0.00
INDEP. CLAIMS	1 -	3 =	0	x \$100.00	\$0.00
Multiple Dependent Claims (check if applicable) <input type="checkbox"/>					\$0.00
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT					\$0.00

No additional fee is required for amendment.

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- Any additional filing fees required under 37 C.F.R. 1.16.
- Any patent application processing fees under 37 CFR 1.17.

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Signature

Mark J. Cohen
Registration No. 32,211
SCULLY, SCOTT, MURPHY & PRESSER
400 Garden City Plaza, Suite 300
Garden City, New York 11530
(516) 742-4343

Dated: July 5, 2005

I certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to "Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450" [37 CFR 1.8(a)] on July 5, 2005.

(Date)



Signature of Person Mailing Correspondence

Mark J. Cohen

Typed or Printed Name of Person Mailing Correspondence

CC:



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Moon-Hee Hong, et al. Examiner: Daniel J. Jenkins
Serial No: 10/724,381 Art Unit: 1742
Filed: November 28, 2003 Docket: 17289
For: **W-Cu ALLOY WITH
HOMOGENOUS MICRO-
STRUCTURE AND THE
MANUFACTURING METHOD THEREOF**
Dated: July 5, 2005

Confirmation No.: 9654

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT UNDER 37 C.F.R. §1.111

Sir:

In response to the Official Action dated April 04, 2005, Applicants submit the following amendment for entry in the above-identified case.

There are no Amendments to the Specification.

Amendments to the Claims begin on page 2 of this paper.

Remarks begin on page 4 of this paper.

CERTIFICATE OF MAILING UNDER 37 C.F.R. §1.8(a)

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Mail Stop Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on July 5, 2005.

Dated: July 5, 2005

Mark J. Cohen